



### **Characteristics**

lo	1.0	Α
VRRM	50~600	V
IFSM	30.0	Α
VF	0.95~1.70	V

#### **Features**

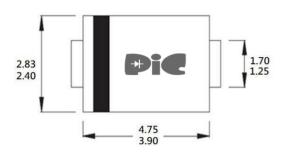
- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- · Super fast speed switching for high efficiency
- Glass Passivated Junction chip
- Low reverse leakage
- High forward surge current capability

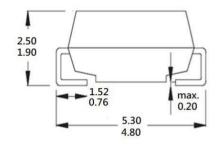
#### **Mechanical Data**

- Case: JEDEC SMA molded plastic body
- Terminals: Solder plated, solderable per
- MIL-STD-750 Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any

## **Package Outline Dimensions**

SMA





Unit: millimeters

#### Maximum Ratings (TA=25°C unless otherwise noted)

	Symbol	ES1A	ES1B	ES1D	ES1G	ES1J	UNITS
Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	Volts
RMS Voltage	VRMS	35	70	140	280	420	Volts
DC Blocking Voltage	VR	50	100	200	400	600	Volts
Average Forward Current	lF(AV)	1.0			Amps		
Peak Forward Surge Current 8.3ms single half sine -wave superimposed on rated load (JEDEC Method)	IFSM			30			Amps
Forward Voltage at 1.0A	VF	0.95 1.25 1.7			1.7	Volts	
DC Reverse Current at Rated TJ=25°C DC Blocking Voltage	IR	5			μА		
Typical Thermal Resistance (NOTE 1)	R⊝JA	60			°C/W		
Operating Junction and Storage Temperature Range	TJ,TSTG	-55~+150			°C		
Reverse Recovery Time ( NOTE 2)	Trr	35			n S		

#### Notes:

- (1) P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas
- (2) Reverse recovery time test condition: IF=0.5A IR=1.0A Irr=0.25A



## **Rating and Characteristics Curves**

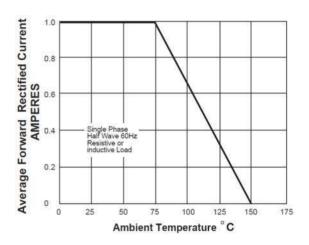


Fig. 1 Forward Current Derating Curve

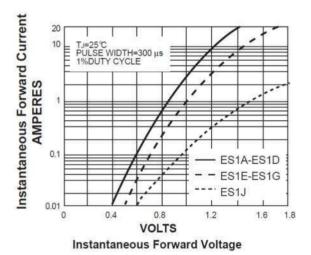


Fig.3 TypicalReverseCharacteristics

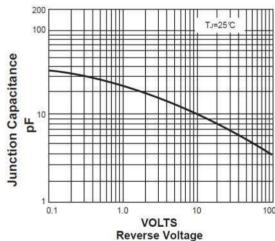


Fig.5 Typical Reverse Characteristics

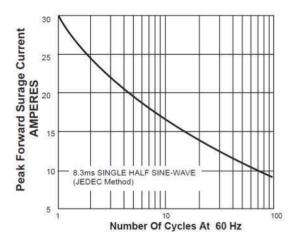


Fig. 2 Typical Junc tion Capacitance

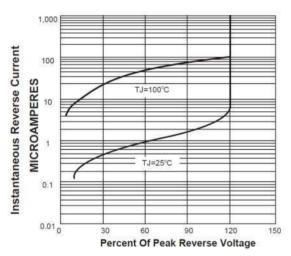


Fig. 4 Typical Forward Characteristics

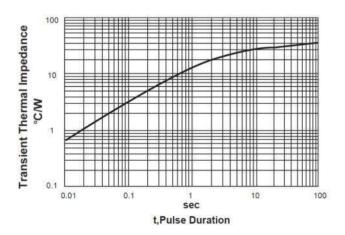
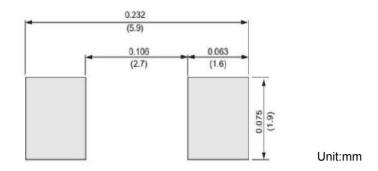


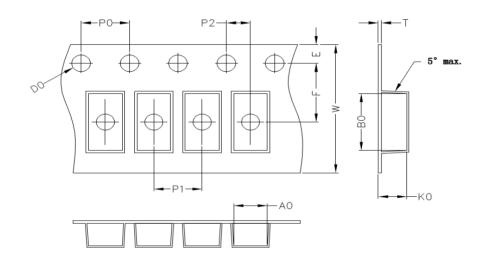
Fig. 6 Typical Transient Thermal Impedance

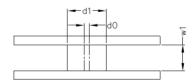


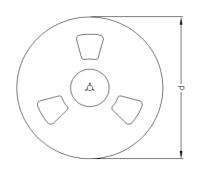
## **Pad Layout**



#### **Packaging Specifications** В0 K0 D0 Ε F P0 P1 P2 Τ W A0 Package (mm) SMA 2.8±0.1 5.33±0.1 2.36±0.1 1.55±0.1 1.75±0.1 5.50±0.1 4.0±0.1 4.0±0.01 2±0.1 0.25±0.1 9.4±0.1 2.45±0.1 1.55±0.1 1.75±0.1 SMB 3.8±0.1 5.40±0.1 5.50±0.1 4.0±0.1 8.0±0.01 2±0.1 0.25±0.1 9.4±0.1 SMC 6.05±0.1 8.31±0.1 2.54±0.1 1.55±0.1 1.75±0.1 7.50±0.1 4.0±0.1 8.0±0.05 2±0.1 0.25±0.1 12±0.1

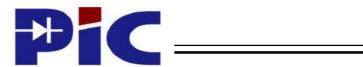




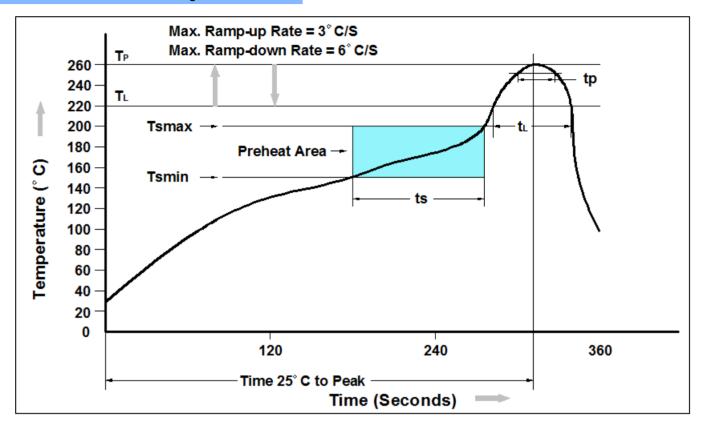


Package	D1 (mm)	D0 (mm)	W1 (mm)	D (mm)
SMA	75	13.5	13.5	330
SMB	75	13.5	13.5	330
SMC	75	13.5	17.0	330

NOTE: The tolerance of reel is ±2mm



## Recommand IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tLto tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

## **Ordering Information**

Part Number	Description	Quantity
ES1A~ES1J	SMA Reel	5000 pcs

# ES1A THRU ES1J



## 1.0A Super Fast Recovery Rectifier

## DISCLAIMER

- The information in this document and any product described herein are subject to change without notice and should not be construed as a commitment by Paceleader, Paceleader reserve the right to make changes to the information in this document.
- Though Paceleader make effort to improve product quality and reliability, Product can malfunction and fail due to their inherent electrical sensitivity and vulnerability to physical stress, it is the responsibility of the customer, when utilizing Paceleader products, to comply with the standards of safety in making a safe design for entire system and to avoid situation in which a malfunction or failure., In developing a new designs, customer should ensure that the device which shown in this documents are used within specified operating ranges.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by Paceleader for any infringements of patents or other rights of the third parties which may result from its use.